## NSN 5962-01-305-3125

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View Online at https://aerobasegroup.com/nsn/5962-01-305-3125

Overall Length:
0.358 inches
Overall Height:
0.100 inches
Overall Width:
0.358 inches
Body Length:
0.358 inches
Body Width:
0.358 inches
Body Height:
0.088 inches
Maximum Power Dissipation Rating:
1.2 watts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Bipolar and burn in and monolithic and programmable
Inclosure Material:
Ceramic
Inclosure Configuration:
Leaded chip carrier
Output Logic Form:
Bipolar metal-oxide semiconductor
Input Circuit Pattern:
16 input
Case Outline Source And Designator:
C-2 mil-m-38510
Current Rating Per Characteristic:
12.00 milliamperes average forward current averaged over a full 60-hz cycle not applicable
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
5.0 volts power source
Memory Device Type:
Pal
Test Data Document:
96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).
Terminal Type And Quantity:

20 pin

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N/a

**Unit Of Measure:** 

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Demilitarization:

No

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